

Title (en)

PRODUCTION OF A STRUCTURE COMPRISING A PROTECTIVE LAYER AGAINST CHEMICAL TREATMENT

Title (de)

HERSTELLUNG EINER STRUKTUR MIT EINER VOR CHEMISCHER BEHANDLUNG SCHÜTZENDEN SCHICHT

Title (fr)

REALISATION D'UNE STRUCTURE COMPRENANT UNE COUCHE PROTEGEANTE CONTRE DES TRAITEMENTS CHIMIQUES

Publication

EP 1649509 A2 20060426 (FR)

Application

EP 04767815 A 20040729

Priority

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- FR 0309380 A 20030730

Abstract (en)

[origin: US2005026391A1] A preventive treatment method for a multilayer semiconductor structure having a support substrate, at least one intermediate layer and a surface layer in which the surface layer is to be subjected to a subsequent chemical treatment. The method includes forming a protective layer between the intermediate layer and the surface layer. The protective layer is made from a material chosen to be sufficiently resistant to the chemical treatment to protect the intermediate layer from chemical attack.

IPC 1-7

H01L 21/762

IPC 8 full level

H01L 21/20 (2006.01); **H01L 21/762** (2006.01)

CPC (source: EP KR US)

H01L 21/76254 (2013.01 - EP US); **H01L 21/76259** (2013.01 - EP US); **H01L 27/12** (2013.01 - KR)

Citation (search report)

See references of WO 2005013338A2

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DOCDB simple family (publication)

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